



Integrated
Circuit
Systems, Inc.

ICS8343-01

LOW SKEW, 1-TO-16

LVC MOS / LV TTL FANOUT BUFFER

GENERAL DESCRIPTION

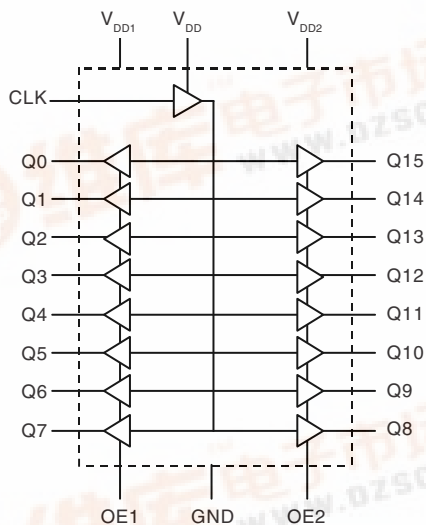


The ICS8343-01 is a low skew, 1-to-16 LVC MOS / LV TTL Fanout Buffer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The ICS8343-01 single ended clock input accepts LVC MOS or LV TTL input levels. The ICS8343-01 operates at 3.3V, 2.5V and mixed 3.3V input and 2.5V supply modes over the commercial temperature range. Guaranteed output and part-to-part skew characteristics make the ICS8343-01 ideal for those clock distribution applications demanding well defined performance and repeatability.

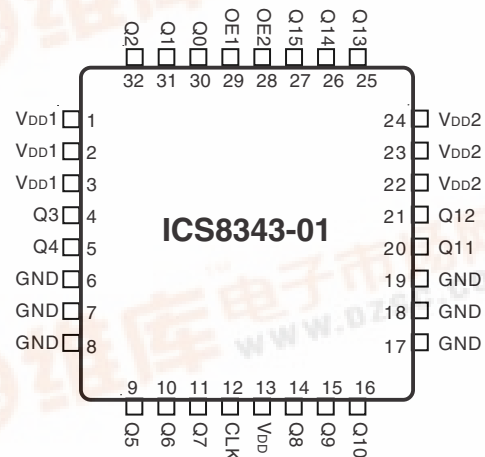
FEATURES

- 16 LVC MOS / LV TTL outputs
- 1 LVC MOS / LV TTL clock input
- CLK can accept the following input levels: LVC MOS, LV TTL
- Maximum output frequency: 200MHz
- Dual output enable inputs facilitates 1-to-16 or 1-to-8 input to output modes
- All inputs are 5V tolerant
- Output skew: 250ps (maximum)
- Part-to-part skew: 700ps (maximum)
- Full 3.3V and 2.5V or mixed 3.3V core/2.5V operating supply
- 0°C to 70°C ambient operating temperature
- Lead-Free package available
- Industrial temperature information available upon request

BLOCK DIAGRAM



PIN ASSIGNMENT



32-Lead LQFP
7mm x 7mm x 1.4mm body package
Y Package
(Top View)



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TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 2, 3	V_{DD1}	Power		Q0 thru Q7 output supply pins.
4, 5	Q3, Q4	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.
6, 7, 8, 17, 18, 19	GND	Power		Power supply ground.
9, 10, 11	Q5, Q6, Q7	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.
12	CLK	Input	Pulldown	LVC MOS/LVTTL clock input / 5V tolerant.
13	V_{DD}	Power		Core supply pin.
14, 15, 16	Q8, Q9, Q10	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.
20, 21	Q11, Q12	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.
22, 23, 24	V_{DD2}	Power		Q8 thru Q15 output supply pins.
25, 26, 27	Q13, Q14, Q15	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.
28	OE2	Input	Pullup	Output enable. When low forces outputs Q8 thru Q15 to HiZ state. 5V tolerant. LVC MOS/LVTTL interface levels.
29	OE1	Input	Pullup	Output enable. When low forces outputs Q0 thru Q7 to HiZ state. 5V tolerant. LVC MOS/LVTTL interface levels.
30, 31, 32	Q0, Q1, Q2	Output		LVC MOS/LVTTL clock outputs. 7 Ω typical output impedance.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
C_{PD}	Power Dissipation Capacitance (per output)	$V_{DD}, V_{DD1}, V_{DD2} = 3.465V$		11		pF
		$V_{DD1}, V_{DD2} = 2.63V$		9		pF
R_{PULLUP}	Input Pullup Resistor			51		K Ω
$R_{PULLDOWN}$	Input Pulldown Resistor			51		K Ω
R_{OUT}	Output Impedance	$V_{DD}, V_{DD1}, V_{DD2} = 3.3V$	5	7	12	Ω

TABLE 3. FUNCTION TABLE

Inputs		Outputs	
OE1	OE2	Q0:Q7	Q8:Q15
0	0	HiZ	HiZ
1	0	Active	HiZ
0	1	HiZ	Active
1	1	Active	Active

NOTE: OE1 and OE2 are 5V tolerant.



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ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to $V_{DD} + 0.5V$
Outputs, V_O	-0.5V to $V_{DDx} + 0.5V$
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, $V_{DD1} = V_{DD2} = 3.3V \pm 5\%$ OR $2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDx}	Output Supply Voltage; NOTE 1		3.135	3.3	3.465	V
			2.375	2.5	2.625	V
I_{DD}	Power Supply Current				35	mA
I_{DDx}	Output Supply Current; NOTE 2				14	mA

NOTE 1: V_{DDx} denotes V_{DD1} and V_{DD2} .

NOTE 2: I_{DDx} denotes the sum of I_{DD1} and I_{DD2} .

TABLE 4B. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V_{DDx}	Output Supply Voltage; NOTE 1		2.375	2.5	2.625	V
I_{DD}	Power Supply Current				34	mA
I_{DDx}	Output Supply Current; NOTE 2				13	mA

NOTE 1: V_{DDx} denotes V_{DD1} and V_{DD2} .

NOTE 2: I_{DDx} denotes the sum of I_{DD1} and I_{DD2} .



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LOW SKEW, 1-TO-16

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TABLE 4C. LVC MOS / LV TTL DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 3.3V \pm 5\%$ OR $2.5V \pm 5\%$;
 $V_{DD} = 3.3V \pm 5\%$, $V_{DD1} = V_{DD2} = 2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	OE1, OE2	2		$V_{DD} + 0.3$	V
		CLK	2		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage	OE1, OE2	-0.3		0.8	V
		CLK	-0.3		1.3	V
I_{IH}	Input High Current	OE1, OE2	$V_{DD} = V_{IN} = 3.465V$ or $2.625V$		5	μA
		CLK	$V_{DD} = V_{IN} = 3.465V$ or $2.625V$		150	μA
I_{IL}	Input Low Current	OE1, OE2	$V_{DD} = 3.465V$ or $2.625V$, $V_{IN} = 0V$	-150		μA
		CLK	$V_{DD} = 3.465V$ or $2.625V$, $V_{IN} = 0V$	-5		μA
V_{OH}	Output High Voltage; NOTE 1	$V_{DD1} = V_{DD2} = 3.465V$	2.6			V
		$V_{DD1} = V_{DD2} = 2.625V$	1.8			V
V_{OL}	Output Low Voltage; NOTE 1	$V_{DD1} = V_{DD2} = 3.465V$ or $2.625V$			0.5	V
I_{OZL}	Output Tristate Current Low				5	μA
I_{OZH}	Output Tristate Current High				5	μA

NOTE 1: Outputs terminated with 50Ω to $V_{DDX}/2$. See Parameter Measurement Information, "Output Load Test Circuit Diagrams".

TABLE 5A. AC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 3.3V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				200	MHz
t_{PLH}	Propagation Delay; NOTE 1	$f \leq 200MHz$	2.0		4.0	ns
$t_{sk(o)}$	Output Skew; NOTE 2, 4	Measured on rising edge @ $V_{DDX}/2$			250	ps
$t_{sk(pp)}$	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @ $V_{DDX}/2$			700	ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.5	ns
odc	Output Duty Cycle	$f \leq 133MHz$	45		55	%
t_{PW}	Output Pulse Width	$f > 133MHz$	$t_{PERIOD}/2 - 0.25$	$t_{PERIOD}/2$	$t_{PERIOD}/2 + 0.25$	ns

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDX}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDX}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDX}/2$.

NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.



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ICS8343-01

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TABLE 5B. AC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, $V_{DD1} = V_{DD2} = 2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				200	MHz
t_{PLH}	Propagation Delay; NOTE 1	$f \leq 200MHz$	2.0		4.5	ns
$tsk(o)$	Output Skew; NOTE 2, 4	Measured on rising edge @ $V_{DDX}/2$			250	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @ $V_{DDX}/2$			700	ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.0	ns
odc	Output Duty Cycle	$f \leq 133MHz$	40		60	%

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDX}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDX}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDX}/2$.

NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 5C. AC CHARACTERISTICS, $V_{DD} = V_{DD2} = 3.3V \pm 5\%$, $V_{DD1} = 2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				200	MHz
$tsk(o)$	Output Skew; NOTE 1	Measured on rising edge @ $V_{DDX}/2$			250	ps

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Defined as skew across outputs at the same supply voltages within a bank, and with equal load conditions.

TABLE 5D. AC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 2.5V \pm 5\%$, $T_A = 0^\circ$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Output Frequency				133	MHz
t_{PLH}	Propagation Delay; NOTE 1	$f \leq 200MHz$	2.0		4.0	ns
$tsk(o)$	Output Skew; NOTE 2, 4	Measured on rising edge @ $V_{DDX}/2$			250	ps
$tsk(pp)$	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @ $V_{DDX}/2$			1	ns
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.0	ns
odc	Output Duty Cycle	$f \leq 133MHz$	40		60	%

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDX}/2$ of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDX}/2$.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDX}/2$.

NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.



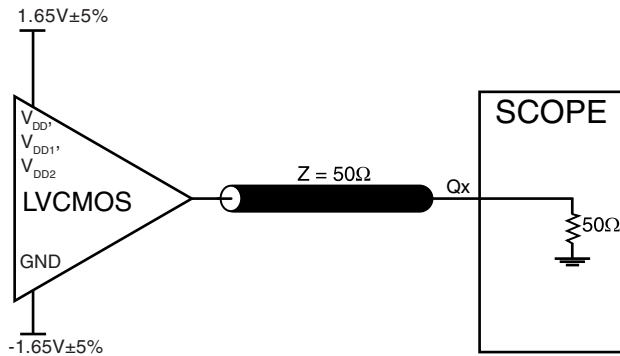
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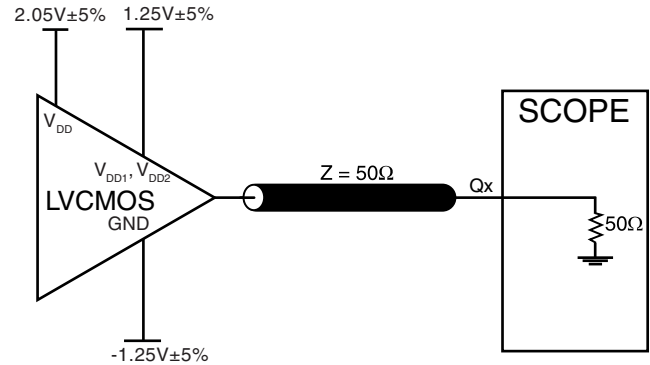
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LVC MOS / LV TTL FANOUT BUFFER

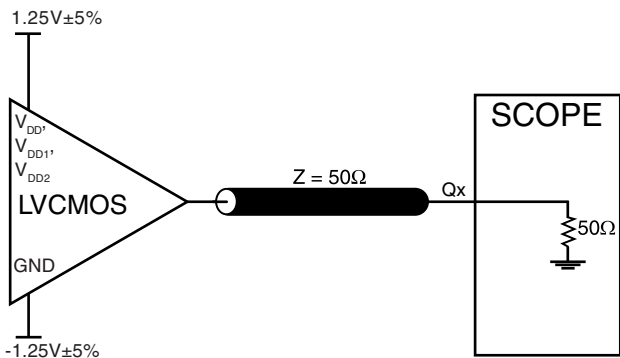
PARAMETER MEASUREMENT INFORMATION



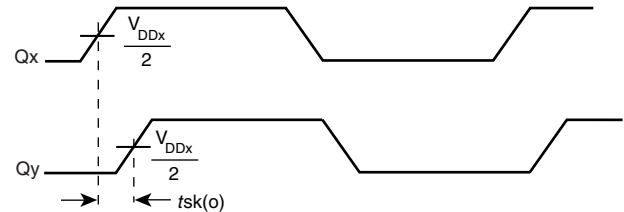
3.3V CORE/ 3.3V OUTPUT LOAD AC TEST CIRCUIT



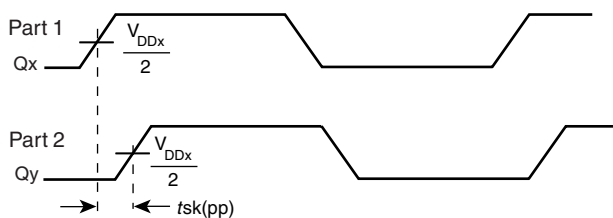
3.3V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT



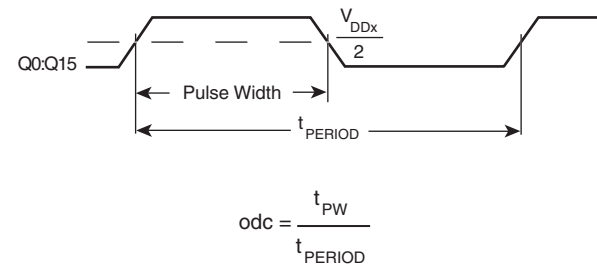
2.5V CORE/ 2.5V OUTPUT LOAD AC TEST CIRCUIT



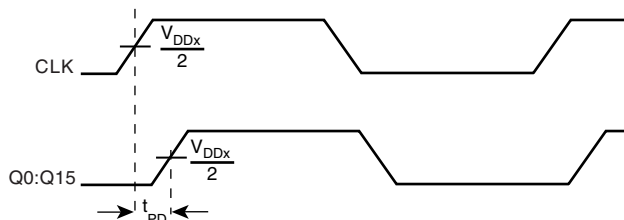
OUTPUT SKEW



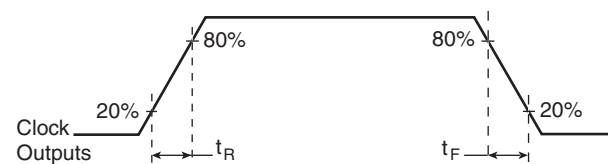
PART-TO-PART SKEW



OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



PROPAGATION DELAY



OUTPUT RISE/FALL TIME



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RELIABILITY INFORMATION

TABLE 6. θ_{JA} vs. AIR FLOW TABLE FOR 32 LEAD LQFP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS8343-01 is: 985



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ICS8343-01

LOW SKEW, 1-TO-16
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PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

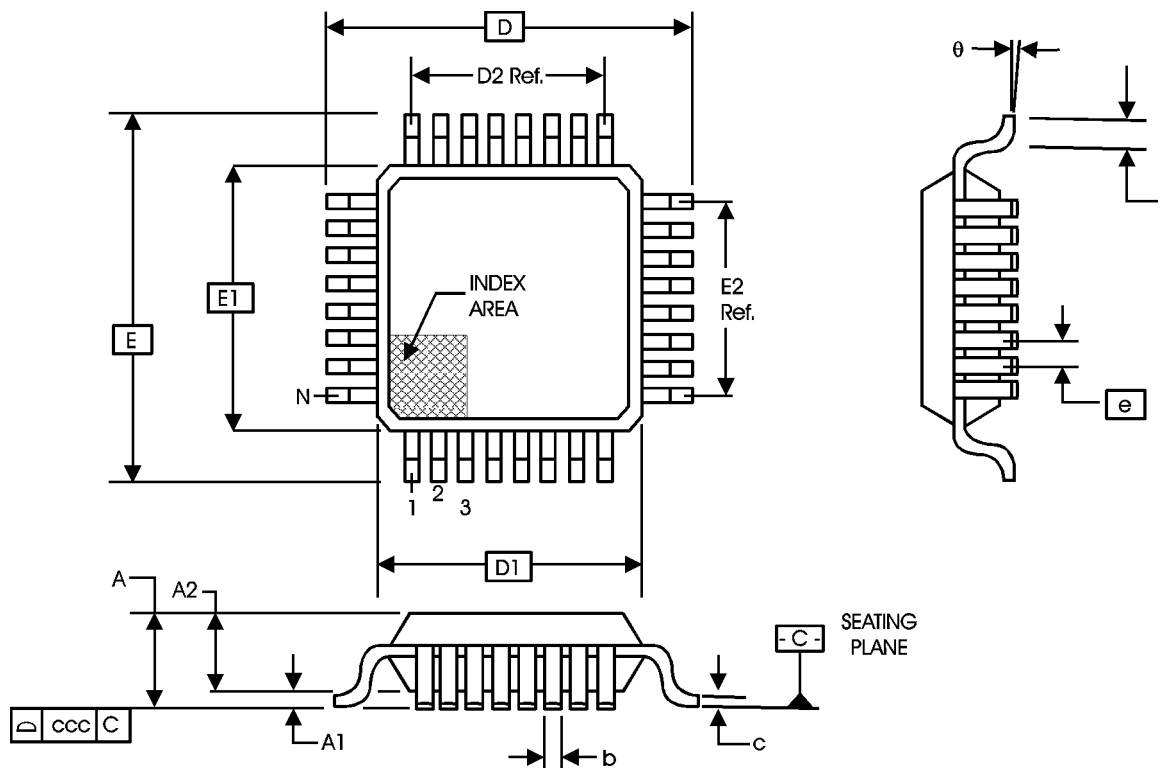


TABLE 7. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N	32		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.60 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.60 Ref.		
e	0.80 BASIC		
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.10



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TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Count	Temperature
ICS8343AY-01	ICS8343AY-01	32 Lead LQFP	250 per tray	0°C to 70°C
ICS8343AY-01T	ICS8343AY-01	32 Lead LQFP on Tape and Reel	1000	0°C to 70°C
ICS8343AY-01LF	ICS8343AY01L	32 Lead "Lead-Free" LQFP	250 per tray	0°C to 70°C
ICS8343AY-01LFT	ICS8343AY01L	32 Lead "Lead-Free" LQFP on Tape and Reel	1000	0°C to 70°C

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REVISION HISTORY SHEET				
Rev	Table	Page	Description of Change	Date
A	T2	2	Pin Characteristics Table - changed C_{IN} 4pF max to 4pF typical. Added to R_{OUT} , 5 Ω min. and 12 Ω max.	9/18/03
	T8	11	Ordering Information correct package column from 48 Lead to 32 Lead.	
B	T5C	5	Added Mixed AC Characteristics Table. Updated format.	8/13/04
B	T8	9	Added Lead-Free marking to Ordering Information Table.	9/16/04